



P-Channel 150-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)			
- 150	0.295 at V _{GS} = - 10 V	- 8.9 ^c	23.2 nC			
- 150	0.315 at V _{GS} = - 6 V	- 8.6 ^c	23.2 110			

S 8 D S D S D G D 5 Top View

SO-8

Ordering Information: Si4455DY-T1-E3 (Lead (Pb)-free) Si4455DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

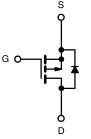
FEATURES

- TrenchFET® Power MOSFET
- 100% R_q and UIS Tested
- Material categorization: For definitions of compliance please see www.vishav.com/doc?99912



APPLICATIONS

- · Active Clamp in Intermediate DC/ **DC** Power Supplies
- · H-Bridge High Side Switch for Lighting Application



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T	A = 25 °C, unless oth	erwise noted)		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V_{DS}	- 150	V
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		- 2.8	
Continuous Drain Current (T = 150 °C)	T _C = 70 °C		- 2.3	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	- 2 ^{a, b}	
	T _A = 70 °C		- 1.6 ^{a, b}	Α
Pulsed Drain Current	I _{DM}	- 15	A	
Continuous Source-Drain Diode Current	T _C = 25 °C	1.	- 4.9	
Continuous Source-Drain Diode Current	T _A = 25 °C	- Is	- 2.5 ^{a, b}	
Avalanche Current	L = 0.1 mH	I _{AS}	- 15	
Single-Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	11.25	mJ
	T _C = 25 °C		5.9	
Maximum Dawar Dissination	T _C = 70 °C	ь	3.8	w
Maximum Power Dissipation	T _A = 25 °C	P _D	3.1 ^{a, b}	VV
	T _A = 70 °C	1	2 ^{a, b}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Based on T_C = 25 °C.

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R _{thJA}	33	40	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	17	21	C/VV	

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. Maximum under steady state conditions is 80 °C/W.

Document Number: 68631 S13-1371-Rev. C, 24-Jun-13 For technical questions, contact: pmostechsupport@vishav.com

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 150			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 165		\//0C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η = - 250 μΑ		- 6.6		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 2		- 4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zara Cata Valtaga Drain Current	1	V _{DS} = - 150 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 150 V, V _{GS} = 0 V, T _J = 55 °C			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 8			Α	
	D	V _{GS} = - 10 V, I _D = - 4 A		0.245	0.295		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 6 V, I _D = - 3 A		0.260	0.315	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = 4 A		12		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1190			
Output Capacitance	C _{oss}	$V_{DS} = -50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		61		pF	
Reverse Transfer Capacitance	C _{rss}			42			
Tatal Oaks Observe		$V_{DS} = -75 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3 \text{ A}$		27.5	27.5 42		
Total Gate Charge				23.2	35		
Gate-Source Charge	Q_{gs}	$V_{DS} = -75 \text{ V}, V_{GS} = -6 \text{ V}, I_{D} = -3 \text{ A}$		5.4		nC	
Gate-Drain Charge	Q_{gd}			8.4			
Gate Resistance	R_g	f = 1 MHz		6.1	9.2	Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	$V_{DD} = -75 \text{ V, R}_{L} = 25 \Omega$		95	145		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong -3 \text{ A}, V_{GEN} = -6 \text{ V}, R_g = 1 \Omega$		38	60		
Fall Time	t _f			34	51		
Turn-On Delay Time	t _{d(on)}			11	18	ns	
Rise Time	t _r	$V_{DD} = -75 \text{ V, R}_{L} = 25 \Omega$		28	42		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong -3 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$		52	78		
Fall Time	t _f			35	53		
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 13		
Pulse Diode Forward Current ^a	I _{SM}				- 15	Α	
Body Diode Voltage	V _{SD}	I _S = - 3 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			65	90	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 4 A, dl/dt = 100 A/μs, T _J = 25 °C		180	270	nC	
Reverse Recovery Fall Time	t _a			45			
Reverse Recovery Rise Time	t _b			20		ns	

Notes:

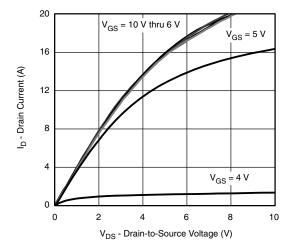
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

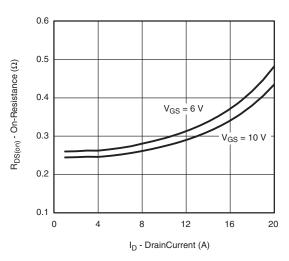
b. Guaranteed by design, not subject to production testing.



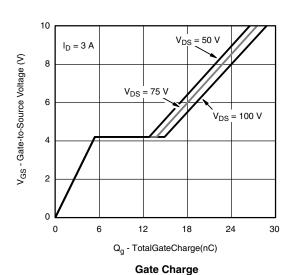
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

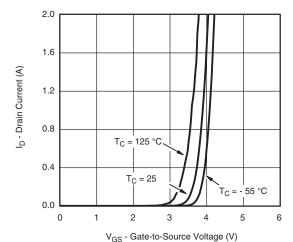


Output Characteristics

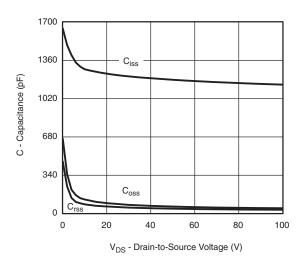


On-Resistance vs. Drain Current and Gate Voltage

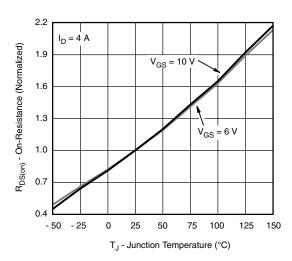




Transfer Characteristics



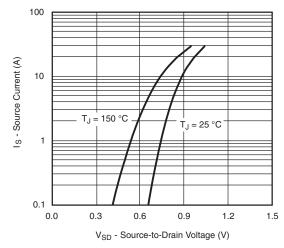
Capacitance



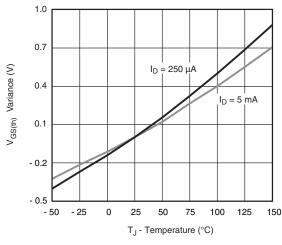
On-Resistance vs. Junction Temperature

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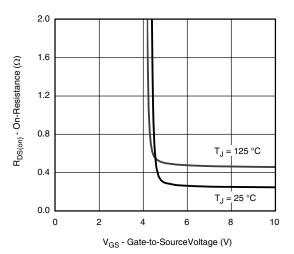
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



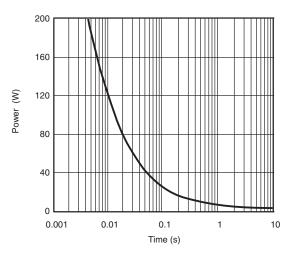
Source-Drain Diode Forward Voltage



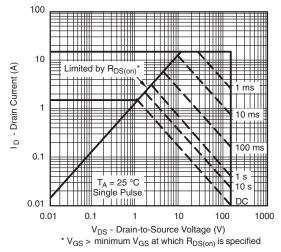
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



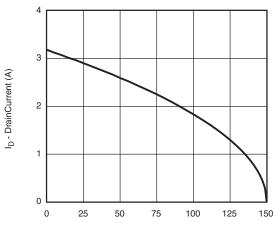
Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

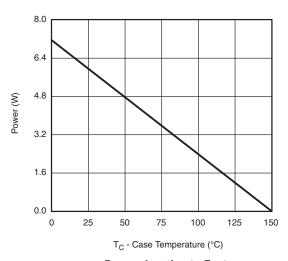


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

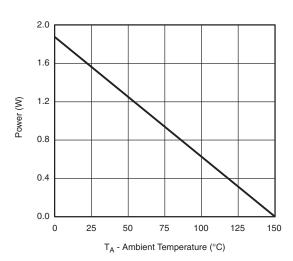


T_C - Case Temperature (°C)

Current Derating*







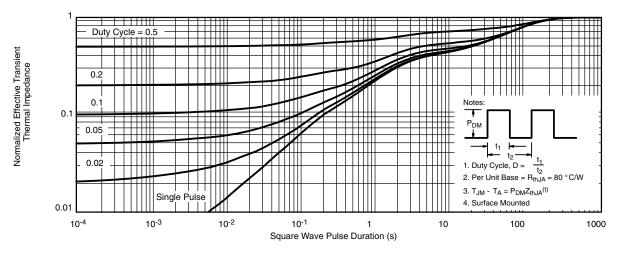
Power, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max.)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heats inking is used. It is used to determine the current rating, when this rating falls below the package limit.

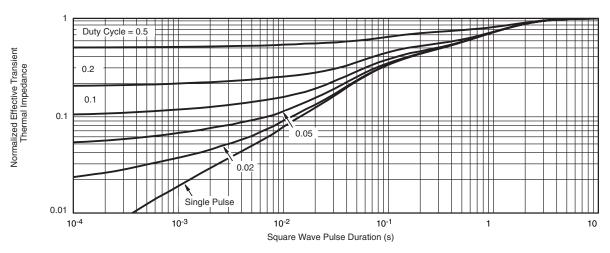
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



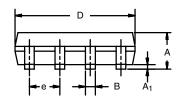
Normalized Thermal Transient Impedance, Junction-to-Foot

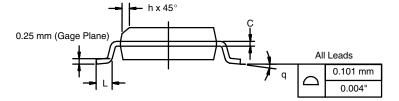
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

APPLICATION NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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